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Keynotes

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Alois Linder, Henkel KGaA

Kathleen Cooper (no PPT available)

Morning Sessions

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Dr. Hervé Heinrich, Accelerated Growth Through e-Marketing

Kurt Anderson, Quality Scorecards for Sealants – Internally and Externally

Séverine RANC SEYVET, Collaborative Innovation in the Chemical Industry

Mike Moore, P.E., Research Update on the Use of Adhesives to Strengthen Residential Roof Systems

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Marga Acevedo, [New Reactive Hot Melt Technology for the Window Industry - Beyond IG Sealants to Bonded Window Adhesives](#)

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Masao Inoue, [Adhesives and the New Four Volatile Organic Compound \(VOC\) Countermeasures in Japan](#)

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[Andre Ladurelli](#), Bostik

[Jack Giampalmi](#)

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Bernard Ghyoot, Europe (FEICA)

Sean Gogarty, Canada (ASMAC)

Arturo Navarrette, Mexico (ANIQ)

Gunther Faltin, Brazil/Latin America (Brascola LTDA)

David Nick, USA (DPNA International, Inc.)

